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STGW25H120F2, STGWA25H120F2

Trench gate field-stop IGBT, H series 1200 V, 25 A high speed

Datasheet - production data

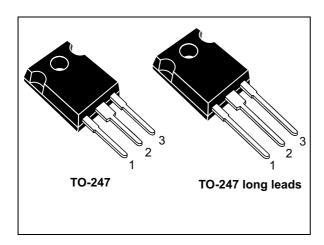
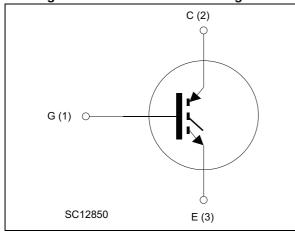


Figure 1. Internal schematic diagram



Features

- Maximum junction temperature: T_J = 175 °C
- · High speed switching series
- Minimized tail current
- $V_{CE(sat)} = 2.1 \text{ V (typ.)} @ I_C = 25 \text{ A}$
- 5 μs minimum short circuit withstand time at T_{.I}=150 °C
- Tight parameters distribution
- Safe paralleling
- Low thermal resistance

Applications

- Uninterruptible power supply
- Welding machines
- Photovoltaic inverters
- · Power factor correction
- · High frequency converters

Description

These devices are IGBTs developed using an advanced proprietary trench gate field-stop structure. These devices are part of the H series of IGBTs, which represent an optimum compromise between conduction and switching losses to maximize the efficiency of high switching frequency converters. Moreover, a slightly positive $V_{\text{CE(sat)}}$ temperature coefficient and very tight parameter distribution result in safer paralleling operation.

Table 1. Device summary

Order code	Marking	Package	Packaging
STGW25H120F2	G25H120F2	TO-247	Tube
STGWA25H120F2	G25H120F2	TO-247 long leads	Tube

Contents

1	Electrical ratings
2	Electrical characteristics
	2.1 Electrical characteristics (curves)
3	Test circuits
4	Package information
	4.1 TO-247, package information
	4.2 TO-247 long leads, package information
5	Revision history

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	1200	V
I _C	Continuous collector current at T _C = 25 °C	50	Α
I _C	Continuous collector current at T _C = 100 °C	25	Α
I _{CP} ⁽¹⁾	Pulsed collector current	100	Α
V _{GE}	Gate-emitter voltage	±20	V
P _{TOT}	Total dissipation at T _C = 25 °C	375	W
T _{STG}	Storage temperature range	-55 to 150	°C
TJ	Operating junction temperature	-55 to 175	°C

^{1.} Pulse width limited by maximum junction temperature

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case	0.4	°C/W
R _{thJA}	Thermal resistance junction-ambient	50	°C/W

2 Electrical characteristics

 $T_J = 25$ °C unless otherwise specified.

Table 4. Static characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 2 mA	1200			٧
V _{CE(sat)} Collector-e voltage		$V_{GE} = 15 \text{ V}, I_{C} = 25 \text{ A}$		2.1	2.6	
	Collector-emitter saturation	V _{GE} = 15 V, I _C = 25 A T _J = 125 °C		2.4		٧
	10 Kago	V _{GE} = 15 V, I _C = 25 A T _J = 175 °C		2.5		
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 1 \text{ mA}$	5	6	7	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} = 1200 V			25	μΑ
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ± 20 V			250	nA

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies}	Input capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0	-	2010	-	pF
C _{oes}	Output capacitance		-	146	-	pF
C _{res}	Reverse transfer capacitance		-	49	-	pF
Qg	Total gate charge	V _{CC} = 960 V, I _C = 25 A, V _{GF} = 15 V, see <i>Figure 23</i>	-	100	-	nC
Q _{ge}	Gate-emitter charge		-	11	-	nC
Q_{gc}	Gate-collector charge	al system	-	52	-	nC

Table 6. Switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	29	-	ns
t _r	Current rise time		-	12	-	ns
(di/dt) _{on}	Turn-on current slope		-	1774	-	A/μs
t _{d(off)}	Turn-off delay time	$V_{CE} = 600 \text{ V}, I_{C} = 25 \text{ A},$		130	-	ns
t _f	Current fall time	$R_G = 10 \Omega$, $V_{GE} = 15 V$, see <i>Figure 22</i>	-	106	-	ns
E _{on} ⁽¹⁾	Turn-on switching losses	J	-	0.6	-	mJ
E _{off} ⁽²⁾	Turn-off switching losses		-	0.7	-	mJ
E _{ts}	Total switching losses		-	1.3	-	mJ
t _{d(on)}	Turn-on delay time		-	27.5	-	ns
t _r	Current rise time		-	13.5	-	ns
(di/dt) _{on}	Turn-on current slope		-	1522	-	A/μs
t _{d(off)}	Turn-off delay time	$V_{CE} = 600 \text{ V}, I_{C} = 25 \text{ A},$	-	139	-	ns
t _f	Current fall time	$R_G = 10 \Omega$, $V_{GE} = 15 V$, $T_{J} = 175 ^{\circ}C$, see <i>Figure 22</i>	-	200	-	ns
E _{on} ⁽¹⁾	Turn-on switching losses		-	1.05	-	mJ
E _{off} ⁽²⁾	Turn-off switching losses		-	1.65	-	mJ
E _{ts}	Total switching losses		-	2.7	-	mJ
t _{sc}	Short-circuit withstand time	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$ $T_{J} = 150 ^{\circ}\text{C},$	5		-	μs

^{1.} Energy losses include reverse recovery of the external diode.

^{2.} Turn-off losses include also the tail of the collector current.

2.1 Electrical characteristics (curves)

Figure 2. Power dissipation vs. case temperature

Figure 3. Collector current vs. case temperature

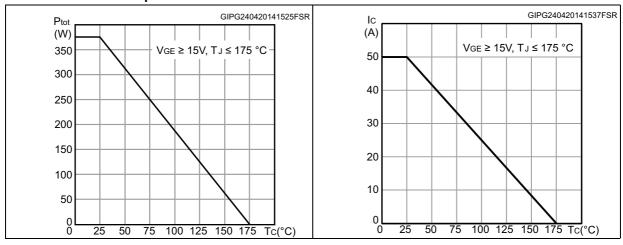


Figure 4. Output characteristics $(T_J = 25^{\circ}C)$

Figure 5. Output characteristics $(T_J = 175^{\circ}C)$

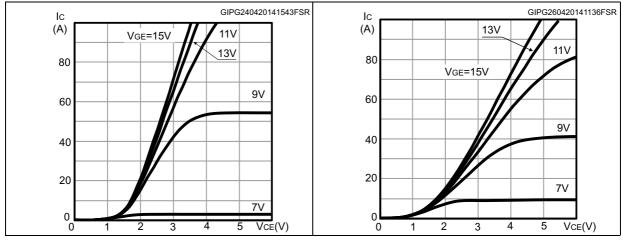
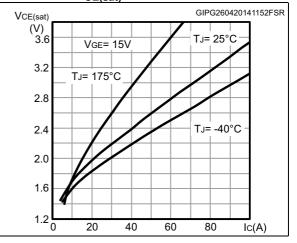


Figure 6. V_{CE(sat)} vs. junction temperature

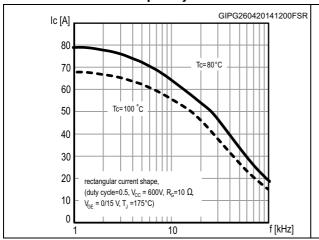
Figure 7. V_{CE(sat)} vs. collector current



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Figure 8. Collector current vs. switching frequency

Figure 9. Forward bias safe operating area



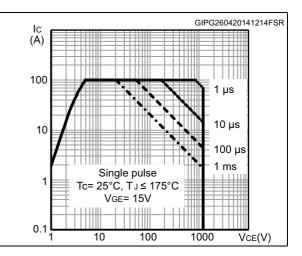
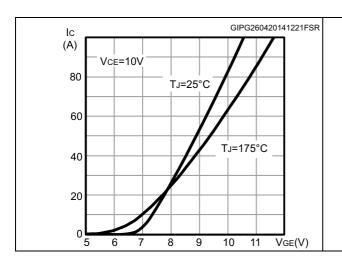


Figure 10. Transfer characteristics

Figure 11. Normalized $V_{GE(th)}$ vs junction temperature



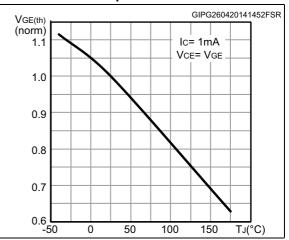
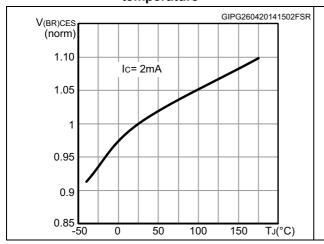


Figure 12. Normalized $V_{(BR)CES}$ vs. junction temperature

Figure 13. Capacitance variation



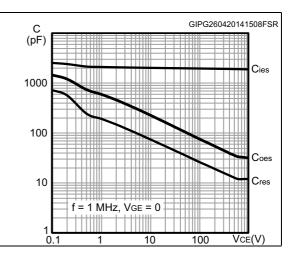


Figure 14. Gate charge vs. gate-emitter voltage Figure 15. Switching loss vs collector current

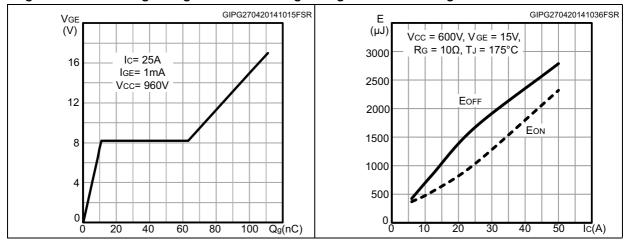


Figure 16. Switching loss vs gate resistance

Figure 17. Switching loss vs temperature

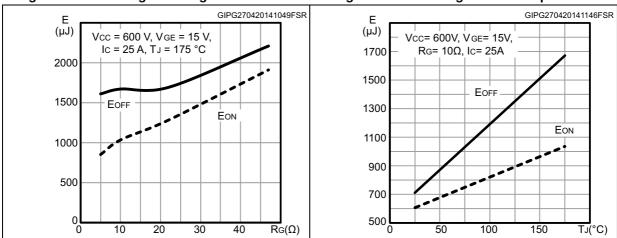
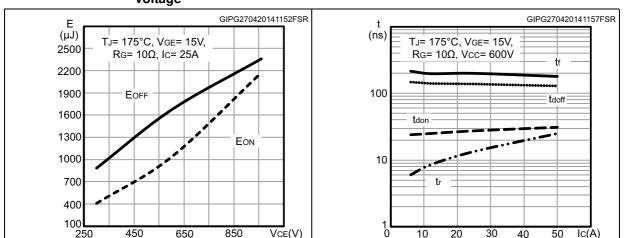
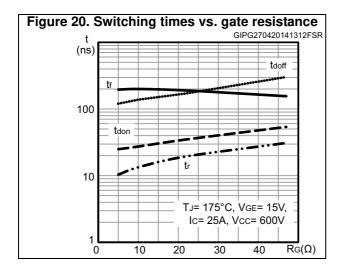


Figure 18. Switching loss vs collector-emitter Figure 19. Switching times vs. collector current voltage



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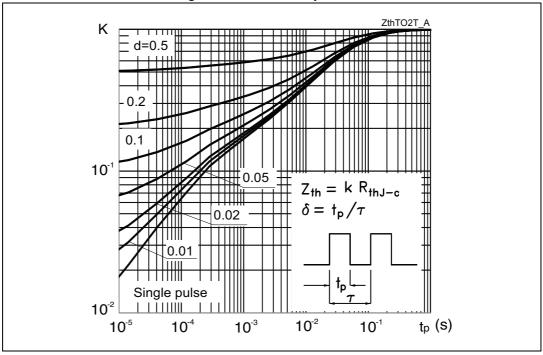


Figure 21. Thermal impedance

3 Test circuits

Figure 22. Test circuit for inductive load switching

Figure 23. Gate charge test circuit

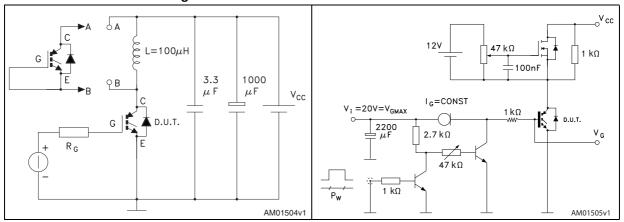
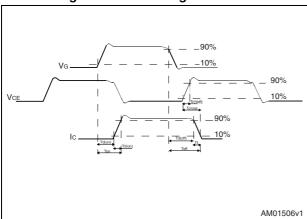


Figure 24. Switching waveform



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247, package information

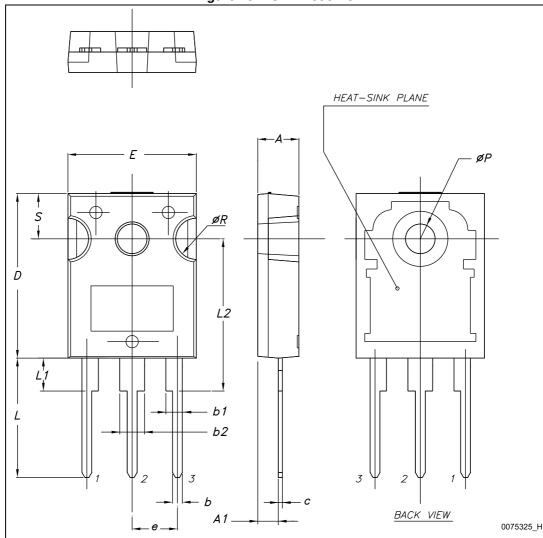


Figure 25. TO-247 outline

Table 7. TO-247 mechanical data

	Tuble 7. To 247 Incondition data				
Dim.		mm.			
Diiii.	Min.	Тур.	Max.		
Α	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
Е	15.45		15.75		
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		

4.2 TO-247 long leads, package information

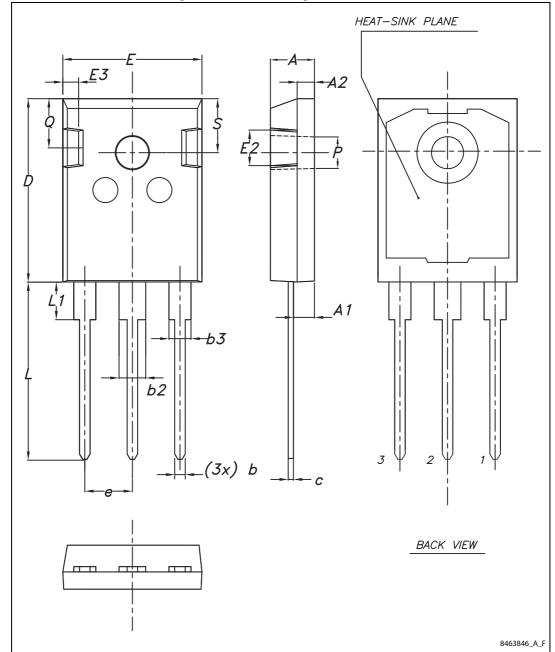


Figure 26. TO-247 long leads outline

Table 8. TO-247 long leads mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
А	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
С	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
е	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
Р	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
28-Feb-2014	1	Initial release.
31-Mar-2014	2	Document status changed from preliminary to production data. Updated Table 4: Static characteristics and Table 6: Switching characteristics (inductive load). Added Section 2.1: Electrical characteristics (curves).
06-Mar-2015	3	Added 4.2: TO-247 long leads, package information Updated Features and Figure 23.: Gate charge test circuit Minor text changes
23-Mar-2015	4	Removed figures with diode Minor text changes.

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